

## TECHNICAL DATA SHEET

SLIDE®

**KLENZ**  
Purging Compound

### KLENZ Purging Compound 468-45, 468-1000

#### Product Description

KLENZ is a revolutionary purging compound requiring no mixing or preparation time. With operating temperatures of 330° - 610°F, KLENZ thoroughly cleanses hot runners and the barrel, helping to eliminate color streaking and black specks. Formulated with a polyolefin resin carrier, KLENZ purging compound is safe to purge right through the mold, saving time, material and money. All ingredients are GRAS rated so it is safe to use for food packaging applications. For use with injection molding, extrusion and blow molding.

#### Applications

Purging Compound

#### Unit Package Description

48 and 1,100 pound boxes

#### Generic Description

Purging Compound

#### Net Weight Fill

45 & 1,000 pounds

#### UPC Code

858799000684

#### Appearance

Resin Pellet

#### Odor

None

#### Flash Point F

>750 degrees

#### Flash Point C

>400 degrees

#### Base Type

Resin

#### Evaporation Rate

N/A

#### HMIS Rating

0, 0, 0, None

#### DOT Proper Shipping Name

Not regulated, Granules, NOI

#### Removal

N/A

#### Units Per Case

45 & 1,000 pounds

#### Case Weight (lbs)

45 / 1,000

#### Working Temperature F

330 to 610 degrees

#### Working Temperature C

165 to 321 degrees

#### Propellant

N/A

#### NFPA Aerosol Flammability Level

N/A

